



Recent Advances in Microwave Devices and Intelligent Systems

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Message from the Guest Editors

Dear Colleagues,

Emerging technologies and application trends encourage the search for new methods for the design and analysis of microwave devices. This poses new challenges regarding how to make the design process fast and accurate. This is especially important when the analysis needs to be repeated many times until the optimal solution is reached. Therefore, this Special Issue intends to present new ideas regarding the implementation of intelligent methods in the design and analysis of microwave devices and other intelligent systems.

Areas relevant to Microwave Devices and Intelligent Systems include, but are not limited to, the design of microwave devices, the analysis of microwave devices, migration from conventional full-wave methods to intelligent methods, intelligent algorithms and systems, and parallel computing.





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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